

• Designed for SDARS IF Receiver

- Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- Differential or Single Ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)



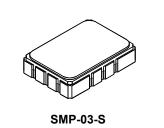
Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Max Soldering Profile	265°C for 10 s	

RFM products are now Murata products.

SF2037B-3

76.500 MHz **SAW** Filter



Electrical Characteristics

Characteristic	Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency	f _C	1			MHz	
Passband Insertion Loss	IL			10.0	12.0	dB
1dB Passband	BW ₁		3.8	4.1		MHz
15dB Bandwidth	BW ₁₅	t f		6.7	6.8	MHz
30dB Bandwidth	BW ₃₀	1		7.7	7.8	MHz
Amplitude Ripple over fc ±1.9 MHz		t f		0.5	1.10	dB _{P-P}
Group Delay Variation over fc ±1.9 MHz	GDV	t t		65	150	ns _{P-P}
Rejection 50 to 65.44 MHz			40	45		
65.44 to 70.44 MHz			39	43		
70.44 to 72.04 MHz			36	43		-
81.26 to 82.56 MHz		1, 3	38	49		dB
82.56 to 86.50 MHz			39	48		-
86.5 to 91.50 MHz			41	48		-
91.50 to 100.000 MHz			45	58		-
Operating Temperature Range		1	-40		+85	°C
Frequency Temperature Coefficient				-18		ppm/°C
Differential Input	175 ohms					
Differential Output	1000 ohms					
Case Style	SMP-03-S 7 x 5 mm Nominal Footprint			otprint		
Lid Symbolization (YY=year, WW=week, S=shift) See note 4		6	RFM SF2037B-3 YYWWS			

Electrical Connections

Connection	Port 1 Hot	Port 1 Ground Return or Hot	Port 2 Hot	Port 2 Ground Return or Hot	Case Ground
Terminals	10	1	5	6	All Others

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer. 1.

2. 3.

- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 4.
- The design, manufacturing process, and specifications of this filter are subject to change. Tape and Reel Standard ANSI / EIA 481. 5
- 6. 7.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. US and international patents may apply. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd. 8
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SMP-03-S Case

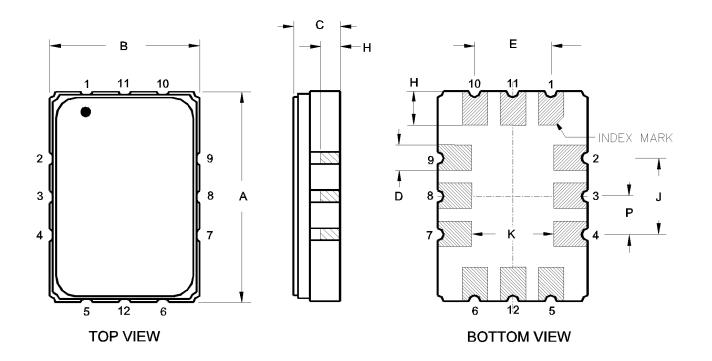
Se Pb 12-Terminal Ceramic Surface-Mount Case

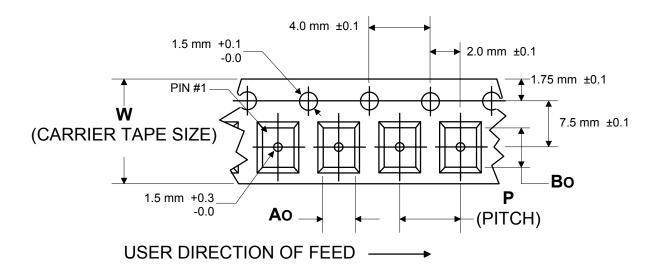
5 x 7 mm Nominal Footprint

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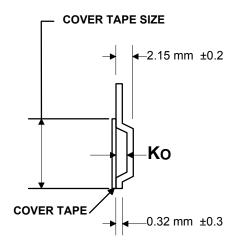
Case Dimensions						
Dimension		mm			Inches	
	Min	Nom	Мах	Min	Nom	Max
Α	6.80	7.00	7.20	0.268	0.276	0.283
В	4.80	5.00	5.20	0.189	0.197	0.205
С		1.65	2.00		0.065	0.079
D		0.80				
E	2.41	2.54	2.67	0.095	0.100	0.105
н	0.87	1.1	1.13	0.034	0.039	0.044
J		2.54				
К		2.8				
Р	1.14	1.27	1.40	0.045	0.050	0.055

Materials				
Solder Pad Termination	Au plating 30 - 60 μinches (76.2-152 μm) over 80- 200 μinches (203-508 μm) Ni.			
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phos- phorus) 100-200 µinches Thick			
Body	Al ₂ O ₃ Ceramic			
Pb Free	•			





COMPONENT ORIENTATION and DIMENSIONS



Carrier Tape Dimensions				
Ao	5.5 mm	±0.1		
Во	7.5 mm	±0.1		
Ko	2.0 mm	±0.1		
Pitch	8.0 mm	±0.1		
W	16.0 mm	±0.3		